501782041 01/10/2012

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Toshiya TERUI	01/05/2012
Tomofumi AKIBA	01/05/2012
Katsuei ISHIDA	01/05/2012
Naoto HAGIWARA	01/05/2012
Satoshi NAGURA	01/05/2012
Shin NAKAGAWA	01/05/2012
Tomohiro TAGUCHI	01/05/2012

RECEIVING PARTY DATA

Name:	TAIYO YUDEN CO.,LTD.	
Street Address:	16-20, Ueno 6-chome	
City:	Taito-ku, Tokyo	
State/Country:	JAPAN	
Postal Code:	110-0005	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13383411

CORRESPONDENCE DATA

 Fax Number:
 (949)457-8297

 Phone:
 949-457-8296

Email: KAPAT@KAPATLAW.COM

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

via US Mail.

501782041

Correspondent Name: Law Office of Katsuhiro Arai

Address Line 1: 22471 Aspan Street

Address Line 2: Suite 205 C

Address Line 4: Lake Forest, CALIFORNIA 92630

PATENT

REEL: 027511 FRAME: 0561

.40.00 1338;

| PAI | REFI: 027511

ATTORNEY DOCKET NUMBER:	TAYUX.080356AP
NAME OF SUBMITTER:	Katsuhiro Arai
Total Attachments: 3 source=ASSIGNMENT_tayux-080356ap_20120110#page1.tif source=ASSIGNMENT_tayux-080356ap_20120110#page2.tif source=ASSIGNMENT_tayux-080356ap_20120110#page3.tif	

PATENT REEL: 027511 FRAME: 0562

ASSIGNMENT

WHEREAS, the undersigned inventor(s) have/has invented certain new and useful improvements in a

ELECTROCHEMICAL DEVICE

and said Application;

for which the undersigned inventor(s)

for which the undersigned inventor(s)
☐ will file an application for Letters Patent in the United States identified as Attorney Docket Number shown in the top margin (hereinafter "Application");
⊠ have/has filed an application, International Application No. PCT/JP2010/059410, filed 06/03/2010, under the Patent Cooperation Treaty, which will enter the U.S. National Phase under 35 U.S.C. §371 (hereinafter "Application");
have/has filed an application for Letters Patent in the United States, Application No, filed (hereinafter "Application");
AND WHEREAS, TAIYO YUDEN CO., LTD, a Japanese corporation, with its principal place of business at 16-20, Ueno 6-chome, Taito-ku, Tokyo, 110-0005, Japan (hereinafter "ASSIGNEE"), desires to acquire the entire right, title, and interest in and to said improvements

NOW, THEREFORE, in return for good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned inventor(s) do/does hereby acknowledge that the undersigned inventor(s) have/has sold, assigned, transferred and set over, and by these presents do/does hereby sell, assign, transfer and set over, unto said ASSIGNEE, its successors, legal representatives and assigns, the entire right, title, and interest throughout the world in, to and under said improvements, and said application, and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all rights of priority under International Conventions and applications for Letters Patent which may hereafter be filed for said improvements in any country or countries foreign to the United States, and all Letters Patent which may be granted for said improvements in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and the undersigned inventor(s) hereby authorize(s) and request(s) the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said improvements to said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument;

AND THE UNDERSIGNED INVENTOR(S) DO/DOES HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, legal representatives, and assigns all claims for damages and all remedies arising out of any violation of the rights assigned hereby that may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to, the right to sue for, collect, and retain damages for past infringements of said Letters Patent before or after issuance;

Page 1/3

Please Direct All Correspondence to Customer Number 76993

AND THE UNDERSIGNED INVENTOR(S) HEREBY covenant(s) and agree(s) that the undersigned inventor(s) will communicate to said ASSIGNEE, its successors, legal representatives and assigns, any facts known to the undersigned inventor(s) respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in all countries.

IN TESTIMONY WHEREOF, the undersigned inventor(s) execute(s) this assignment:

NAME OF SOLE OR FIRST INVENTOR		
first and middle [if any]	FAMILY NAME	
Toshiya	TERUI	
Inventor's Signature	Date	
Toshiya TERUI NAME OF SECOND INVENTOR	01/05/ 2012	
NAME OF SECOND INVENTOR		
first and middle [if any]	FAMILY NAME	
Tomofumi	AKIBA	
Inventor's Signature	Date	
Tomofuni akiba	01/05/2012	
NAME OF THIRD INVENTOR		
first and middle [if any]	FAMILY NAME	
Katsuei	ISHIDA	
Inventor's Signature	Date	
Katsuei Oshida	01 / 05 / z012	
NAME OF FOURTH INVENTOR		
first and middle [if any]	FAMILY NAME	
Naoto	HAGIWARA	
Inventor's Signature	Date	
Naoto HAGIWARA	01 / 05 / 2012	

NAME OF FIFTH INVENTOR	
first and middle [if any]	FAMILY NAME
Satoshi	NAGURA
Inventor's Signature	Date
Satoshi Nagura	01 / 05 / 2012
NAME OF SIXTH INVENTOR	
first and middle [if any]	FAMILY NAME
Shin	NAKAGAWA
Inventor's Signature -	Date
Shin Nakagawa	01/of/2012
NAME OF SEVENTH INVENTOR	
first and middle [if any]	FAMILY NAME
Tomohiro	TAGUCHI
Inventor's Signature	Date
Tomohiro Taguchi	01/05/2012

Page 3/3